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100 MS/s, 14-Bit Digitizers for Communications NI PXI-5142, NI PCI-5142





- 100 MS/s real-time sample rate, up to 2.0 GS/s equivalent-time sample rate
- 14-bit resolution on two simultaneously sampled channels
- 100 MHz analog bandwidth with noise and antialias filters

- Quadrature digital downconversion (DDC) with up to 40 MHz IF bandwidth
- Baseband I/Q decimation with alias protection
- General-purpose alias-protected decimation for all sample rates

Overview

The NI PCI-5142 and PXI-5142 are 100 MS/s digitizers with onboard signal processing (OSP). OSP functions include quadrature digital downconversion (DDC), real digital downconversion, and antialiasing filtering for baseband I/Q decimation and general-purpose applications. NI 5142 devices are ideal for communications applications, but they are also suited for a wide variety of applications in automotive, scientific research, military/aerospace, and consumer electronics. With the large dynamic range, software-selectable 50 Ω or 1 M Ω input, ranges from 200 mV to 20 V, and the ability to acquire more than a half million waveforms in onboard memory, an NI 5142 is ideal for both time- and frequency-domain analysis.

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Ordering Information

For a complete list of accessories, visit the product page on ni.com.

Products	Part Number	Recommended Accessories	Part Number
NI PXI-5142/64_MB			
NI PXI-5142/64 MB Requires: 1 Cables ;	779587-01	Cables: Unshielded - SMB112, Double Shielded SMB to BNC Male Coax Cable, 50 Ohm, 1m **Also Available: [Shielded]	778827-01
NI PCI-5142_64			
NI PCI-5142 64MB/ch Requires: 1 Cables ;	779589-01	Cables: Unshielded - SMB112, Double Shielded SMB to BNC Male Coax Cable, 50 Ohm, 1m **Also Available: [Shielded]	778827-01
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Support and Services

System Assurance Programs

NI system assurance programs are designed to make it even easier for you to own an NI system. These programs include configuration and deployment services for your NI PXI, CompactRIO, or Compact FieldPoint system. The NI Basic System Assurance Program provides a simple integration test and ensures that your system is delivered completely assembled in one box. When you configure your system with the NI Standard System Assurance Program, you can select from available NI system driver sets and application development environments to create customized, reorderable software configurations. Your system arrives fully assembled and tested in one box with your software preinstalled. When you order your system with the standard program, you also receive system-specific documentation including a bill of materials, an integration test report, a recommended maintenance plan, and frequently asked question documents. Finally, the standard program reduces the total cost of owning an NI system by providing three years of warranty coverage and calibration service. Use the online product advisors at ni.com/advisor to find a system assurance program to meet your needs.

Calibration

NI measurement hardware is calibrated to ensure measurement accuracy and verify that the device meets its published specifications. To ensure the ongoing accuracy of your measurement hardware, NI offers basic or detailed recalibration service that provides ongoing ISO 9001 audit compliance and confidence in your measurements. To learn more about NI calibration services or to locate a qualified service center near you, contact your local sales office or visit ni.com/calibration.

Technical Support

Get answers to your technical questions using the following National Instruments resources.

- Support Visit ni.com/support to access the NI KnowledgeBase, example programs, and tutorials or to contact our applications engineers who are located in NI sales offices around the world and speak the local language.
- Discussion Forums Visit forums.ni.com for a diverse set of discussion boards on topics you care about.
- Online Community Visit community.ni.com to find, contribute, or collaborate on customer-contributed technical content with users like you.

Repair

While you may never need your hardware repaired, NI understands that unexpected events may lead to necessary repairs. NI offers repair services performed by highly trained technicians who quickly return your device with the guarantee that it will perform to factory specifications. For more information, visit ni.com/repair.

Training and Certifications

The NI training and certification program delivers the fastest, most certain route to increased proficiency and productivity using NI software and hardware. Training builds the skills to more efficiently develop robust, maintainable applications, while certification validates your knowledge and ability.

- Classroom training in cities worldwide the most comprehensive hands-on training taught by engineers.
- On-site training at your facility an excellent option to train multiple employees at the same time.
- Online instructor-led training lower-cost, remote training if classroom or on-site courses are not possible.
- · Course kits lowest-cost, self-paced training that you can use as reference guides.
- Training memberships and training credits to buy now and schedule training later.

Visit ni.com/training for more information.

Extended Warranty

NI offers options for extending the standard product warranty to meet the life-cycle requirements of your project. In addition, because NI understands that your requirements may change, the extended warranty is flexible in length and easily renewed. For more information, visit ni.com/warranty.

OEM

NI offers design-in consulting and product integration assistance if you need NI products for OEM applications. For information about special pricing and services for OEM customers, visit ni.com/oem.

Alliance

Our Professional Services Team is comprised of NI applications engineers, NI Consulting Services, and a worldwide National Instruments Alliance Partner program of more than 700 independent consultants and integrators. Services range from start-up assistance to turnkey system integration. Visit ni.com/alliance.

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Detailed Specifications

14-Bit 100 MS/s Digitizer with Onboard Signal Processing

This topic lists the specifications for the NI PXI/PCI-5142 (NI 5142) high-speed digitizer. Unless otherwise noted, the following conditions were used for each specification:

- All filter settings
- All impedance selections
- Sample clock set to 100 MS/s

Typical values are used to define an average unit measured at ambient temperatures of 15 °C to 35 °C. Specifications are subject to change without notice. For the most recent NI 5142 specifications, visit ni.com/manuals.

To access NI 5142 documentation, navigate to Start»All Programs»National Instruments»NI-SCOPE»Documentation.



Hot Surface If the NI 5142 has been in use, the device or the shield may exceed safe handling temperatures and may cause burns. Allow the NI 5142 to cool before touching the shield or removing the device from the chassis or PC. Refer to the *Environment* section for operating temperatures.

Vertical

Analog Input (Channel 0 and Channel 1)

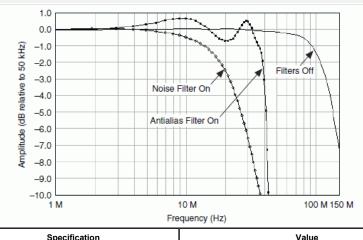
Specification	Value	Comments
Number of Channels	Two (simultaneously sampled)	_
Connector	BNC	_
Impedance and Coupling		

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Specification			Value		Comments
Input Impedance	50 Ω ±2.0%		r	n parallel with a typical	Software selectable.
· ·			capacitance of		
Input Coupling	AC, DC, GND				AC coupling available on 1 M Ω only.
Voltage Levels	1		1		T
Full Scale (FS) Input Range and Programmable Vertical Offset	50 Ω		1 ΜΩ		
	Range (V _{pk-pk})	Vertical Offset Range (V)	Range (V _{pk-pk})	Vertical Offset Range (V)	
	0.2	±0.1	0.2	±0.1	
	0.4	±0.2	0.4	±0.2	
	1	±0.5	1	±0.5	
	2	±1	2	±1	
	4	±2	4	±2	
	10	-	10	±5]
			20	-	7
Maximum Input Overload	50 Ω	-	1 ΜΩ		-
	7 V _{rms} with Pea	ks ≤10 V	Peaks ≤42 V		7
Accuracy					•
Resolution	14 bits				-
DC Accuracy (Programmable Vertical	Range (V _{pk-pk})	50 Ω and 1 $M\Omega$			Within ±5 °C of self-calibration temperature.
Offset = 0 V)	0.2, 0.4		0.05% of locut 1	4.0	-
	,		0.65% of Input + 0.65% of Input +		
	1				-
			0.65% of Input +		
		NI PCI-5142: ±(0.65% of Input +	2.0 mV)	
	2	NI PXI-5142: ±((0.65% of Input +	1.6 mV)	
		NI PCI-5142: ±(0.65% of Input +	2.2 mV)	
	4	NI PXI/PCI-5142	2: ±(0.65% of Inp	ut + 8.0 mV)]
	10	NI PXI-5142: ±(0	0.65% of Input +	8.0 mV)	
		NI PCI-5142: ±(0.65% of Input +	10.0 mV)	
	20 (1 MΩ only)	NI PXI-5142: ±((0.65% of Input +	13.0 mV)	
		NI PCI-5142: ±(0.65% of Input +	15.0 mV)	
Programmable Vertical Offset	±0.4% of offset s	etting			Within ±5 °C of self-calibration temperature.
Accuracy		-			
DC Drift	Range (V _{pk-pk})	$50~\Omega$ and 1 $M\Omega$			_
	0.2, 0.4, 1, and 2	±(0.057% of Inp	ut + 0.006% of F	S + 100 μV) per °C	
	4, 10, and 20 (1 MΩ only)	±(0.057% of Inp	ut + 0.006% of F	S + 900 μV) per °C	
AC Amplitude Accuracy	50 Ω		1 ΜΩ		Within ±5 °C of self-calibration temperature.
	±0.06 dB (±0.7%) at 50 kHz	±0.09 dB (±1.04	%) at 50 kHz	7
Crosstalk, Typical	≤–100 dB at 10 l	MHz	•		CH 0 to/from CH 1, External Trigger to CH 0 or CH 1.
Bandwidth and Transient Response					
Bandwidth (–3 dB)	Range (V _{pk-pk})	50 Ω and 1 $M\Omega$			Filters off.
	All ranges 100 MHz except 0.2			[*] 78 MHz above 40 °C.	
	0.2	80 MHz up to 40	⊃ °C*		1
Rise/Fall Time, Typical	Range (V _{pk-pk})	50 Ω and 1 $M\Omega$			
	All ranges except 0.2	3.5 ns			
	0.2	4.2 ns			

Specification			Value	Comments
Bandwidth Limit Filters	Noise Filter		Antialias Filter	Only one filter can be enabled at any given time. The
	20 MHz 2-pole Bessel filt	er	40 MHz (–6 dB, typical) 35 MHz (–3 dB) 6-pole Chebyshev filter	antialias filter is enabled by default.
AC Coupling Cutoff (-3 dB)	12 Hz			AC coupling available on 1 M Ω only.
Passband Flatness	Filter Settings	Range (V _{pk-pk})	50 Ω and 1 $M\Omega$	Referenced to 50 kHz.
	Filters Off	All ranges except 0.2	±0.4 dB DC to 20 MHz ±1 dB 20 MHz to 50 MHz	
		0.2	±0.4 dB DC to 20 MHz ±1 dB 20 MHz to 40 MHz	
	Antialias Filter On	All ranges	±1.2 dB DC to 16 MHz ±1.6 dB 16 MHz to 32 MHz	

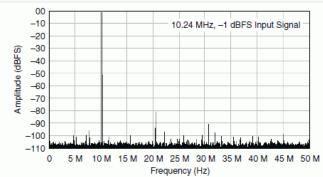
NI 5142 Frequency Response (Typical)



Specification	Value				Comments	
Spectral Characteristics	·					
Spurious-Free Dynamic Range with Harmonics (SFDR), Typical	Range (V _{pk-pk})	Ŭ, (1 ΜΩ		10 MHz, –1 dBFS input signal.
	0.2	75 dBc		70 dBc		Includes the 2 nd through the 5 th harmonics.
	0.4	75 dBc		70 dBc		Measured from DC to 50 MHz on NI PXI-5142.
	1	75 dBc		70 dBc		Measured from 5 kHz to 50 MHz on NI PCI-5142.
	2	75 dBc		70 dBc		
	4	65 dBc		70 dBc		
	10	65 dBc		60 dBc		
	20 (1 MΩ only)	N/A		60 dBc		
Total Harmonic Distortion (THD), Typical	Range (V _{pk-pk})	50 Ω		1 ΜΩ		10 MHz, –1 dBFS input signal.
	0.2	2 –75 dBc		–68 dBc		Includes the 2 nd through the 5 th harmonics.
	0.4	–75 dBc		–68 dBc		
	1	–75 dBc		–68 dBc		
	2	–73 dBc		–68 dBc		
	4	–63 dBc		–68 dBc		
	10	–63 dBc		–58 dBc		
	20 (1 MΩ only)	N/A		–58 dBc		
Intermodulation Distortion, Typical	0.2 V _{pk-pk} to	2.0 V _{pk-pk}	Ranges on 50 Ω	Input		Two tones at 10.2 MHz and 11.2 MHz. Each tone is
	–75 dBc					-7 dBFS.
Signal-to-Noise Ratio (SNR), Typical	Range (V	50 Ω		1 MΩ		10 MHz, –1 dBFS input signal.
	_{pk-pk})	Filters Off	Antialias Filter On	Filters Off	Antialias Filter On	Excludes harmonics.
	0.2	60 dB	60 dB	56 dB	60 dB	Measured from DC to 50 MHz.

Specification			Value			Comments
	0.4	62 dB	62 dB	61 dB	62 dB	
	1	62 dB	62 dB	62 dB	62 dB	
	2	62 dB	62 dB	62 dB	62 dB	
	4	-	—	61 dB	62 dB	
Signal to Noise and Distortion (SINAD), Typical	Range (V	50 Ω		1 MΩ		10 MHz, –1 dBFS input signal.
	pk-pk)	Filters Off	Antialias Filter On	Filters Off	Antialias Filter On	Includes harmonics.
	0.2	60 dB	60 dB	56 dB	59 dB	Measured from DC to 50 MHz.
	0.4	62 dB	62 dB	60 dB	61 dB	
	1	62 dB	62 dB	61 dB	61 dB	
	2	62 dB	62 dB	61 dB	61 dB	
	4	-	_	60 dB	61 dB	

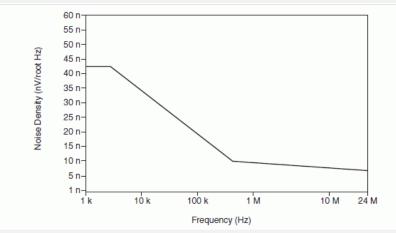
NI 5142 Dynamic Performance, 50 $\Omega,$ 1 $V_{pk\text{-}pk}$ Range (Typical)



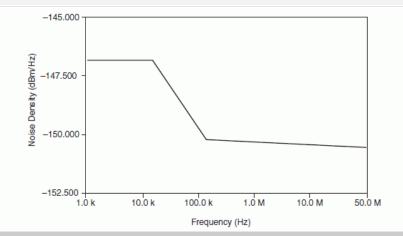
0 10 11		quency (Hz)		
Specification	Value		[Comments
RMS Noise (Noise Filter On)	Range (V _{pk-pk})	50 Ω	1 ΜΩ	50 Ω terminator connected to input
	0.2	NI PXI-5142: 46 μV _{rms} (0.023% FS)	NI PXI-5142: 60 μV _{rms} (0.030% FS)	
		NI PCI-5142: 56 μV _{rms} (0.028% FS)	NI PCI-5142: 72 μV _{rms} (0.036% FS)	
	0.4	92 µV _{rms} (0.023% FS)	92 μV _{rms} (0.023% FS)	
	1	230 µV _{rms} (0.023% FS)	230 μV _{rms} (0.023% FS)	
	2	460 μV _{rms} (0.023% FS)	460 μV _{rms} (0.023% FS)	
	4	920 μV _{rms} (0.023% FS)	920 μV _{rms} (0.023% FS)	
	10	2.3 mV _{rms} (0.023% FS)	2.3 mV _{rms} (0.023% FS)	
	20 (1 MΩ only)	N/A	4.6 mV _{rms} (0.023% FS)	
Specification	Value		Comments	
RMS Noise (Antialias Filter On)	Range (V _{pk-pk})	50 Ω	1 ΜΩ	50 Ω terminator connected to input
	0.2	NI PXI-5142: 66 µV _{rms} (0.033% FS)	NI PXI-5142: 80 µV _{rms} (0.040% FS)	
		NI PCI-5142: 82 µV _{rms} (0.041% FS)	NI PCI-5142: 96 µV _{rms} (0.048% FS)	
	0.4	100 μV _{rms} (0.025% FS)	120 μV _{rms} (0.030% FS)	
	1	250 μV _{rms} (0.025% FS)	300 μV _{rms} (0.030% FS)	
	2	500 μV _{rms} (0.025% FS)	600 μV _{rms} (0.030% FS)	
	4	1 mV _{rms} (0.025% FS)	1.2 mV _{rms} (0.030% FS)	
	10	2.5 mV _{rms} (0.025% FS)	3 mV _{rms} (0.030% FS)	
	20 (1 MΩ only)	N/A	6 mV _{rms} (0.030% FS)	
Specification	Value			Comments
RMS Noise (Filters Off)	Range (V _{pk-pk})	50 Ω	1 ΜΩ	50 Ω terminator connected to inpu
	0.0		110 μV _{rms} (0.055% FS)	L
	0.2	NI PXI-5142: 66 µV _{rms} (0.033% FS)	110 µ v _{ms} (0.000 /01 0)	

	NI PCI-5142: 90 µV _{rms} (0.045% FS)		
0.4	100 μV _{rms} (0.025% FS)	160 μV _{rms} (0.040% FS)	
1	250 μV _{rms} (0.025% FS)	300 μV _{rms} (0.030% FS)	
2	500 μV _{rms} (0.025% FS)	600 μV _{rms} (0.030% FS)	
4	1 mV _{rms} (0.025% FS)	1.6 mV _{rms} (0.040% FS)	
10	2.5 mV _{rms} (0.025% FS)	3 mV _{rms} (0.030% FS)	
20 (1 MΩ only)	N/A	6 mV _{rms} (0.030% FS)	

Representation of NI 5142 Spectral Noise Density on 0.2 V Range, Noise Filter Enabled, 1 MΩ Input Impedance



Representation of NI 5142 Spectral Noise Density on 0.2 V Range, Full Bandwidth, 50 Ω Input Impedance



Horizontal

Sample Clock

Specification	Value	9	Comments
Sources	NI PXI-5142	NI PCI-5142	* Internal Sample Clock is locked to the Reference Clock or derived from the onboard VCXO.
	Internal, Onboard Clock (internal VCXO) [*] External, CLK IN (front panel SMB connector) External, PXI Star Trigger (backplane connector)	Internal, Onboard Clock (internal VCXO) [*] External, CLK IN (front panel SMB connector)	
Onboard Clock (Internal VCXO)		
Sample Rate Range	Real-Time Sampling (Single Shot)	Random Interleaved Sampling (RIS)	* In normal operation mode (non-OSP mode), divide by n decimation is used for all rates less than 100 MS/s. For more information about Sample Clock and decimation, refer to the <i>NI High-Speed</i>
	1.526 kS/s to 100 MS/s [*]	200 MS/s to 2 GS/s in multiples of 100 MS/s	Digitizers Help. Non-OSP decimation does not protect the acquired data from undersampling aliasing. Non-OSP decimation and OSP decimation are mutually exclusive.

Specification	Value		Comments
Phase Noise Density, Typical	<-100 dBc/Hz at 100 Hz <-120 dBc/Hz at 1 kHz <-130 dBc/Hz at 10 kHz		10 MHz input signal.
Sample Clock Jitter, Typical	≤1 ps rms (100 Hz to 100 kH ≤2 ps rms (100 Hz to 1 MHz		Includes the effects of the converter aperture uncertainty and the clock circuitry jitter. Excludes trigger jitter.
Timebase Frequency	100 MHz		
Timebase Accuracy	Not Phase-Locked to Reference Clock	Phase-Locked to Reference Clock	ppm = parts per million (1×10^{-6})
	±25 ppm	Equal to the Reference Clock accuracy	
Sample Clock Delay Range	±1 Sample Clock period		_
Sample Clock Delay Resolution	≤10 ps		-
External Sample	Clock		
Sources	NI PXI-5142	NI PCI-5142	_
	CLK IN (front panel SMB connector)	CLK IN (front panel SMB connector)	
	PXI Star Trigger (backplane connector)		
Frequency Range	30 MHz to 105 MHz (CLK IN 30 MHz to 80 MHz (PXI Star		In normal operation mode (non-OSP mode), divide by <i>n</i> decimation is available where $1 \le n \le 65,535$. For more information about Sample Clock and decimation, refer to the <i>NI High-Speed Digitizers Help</i> . Non-OSP decimation does not protect the acquired data from undersampling aliasing. Non-OSP decimation and OSP decimation are mutually exclusive.
Duty Cycle Tolerance	45% to 55%		
Sample Clock Ex	porting		
Exported	Destination	Maximum Frequency	* Decimated Sample Clock only.
Sample Clock Destinations	CLK OUT (front panel SMB connector)	105 MHz	
	PXI_Trig <06> (backplane connector) [*]	20 MHz	
	PFI <01> (front panel 9-pin mini-circular DIN connector) [*]	25 MHz	
	RTSI<06> [*]	20 MHz	

Phase-Locked Loop (PLL) Reference Clock

Specification	Va	lue	Comments	
Sources	NI PXI-5142	NI PCI-5142	-	
	PXI_CLK10 (backplane connector)	RTSI 7		
	CLK IN (front panel SMB connector)			
Frequency Range	1 MHz to 20 MHz in 1 MHz increments. Default of 10 MHz.			
	The PLL Reference Clock frequency has to be accurate to ±50 ppm.			
Duty Cycle Tolerance	45% to 55%		-	
Exported Reference Clock Destinations	NI PXI-5142	NI PCI-5142	-	
	CLK OUT (front panel SMB connector)	CLK OUT (front panel SMB connector)		
	PFI <01> (front panel 9-pin mini-circular DIN connector) PFI <01> (front panel 9-pin mini-circular DIN connector)			
	PXI_Trig <07> (backplane connector)	RTSI <07>		

CLK IN (Sample Clock and Reference Clock Input, Front Panel Connector)

Specification	Value	Comments
Input Voltage Range	Sine wave: 0.65 V _{pk-pk} to 2.8 V _{pk-pk} (0 dBm to 13 dBm) Square wave: 0.2 V _{pk-pk} to 2.8 V _{pk-pk}	_
Maximum Input Overload	7 V _{rms} with Peaks ≤10 V	Overvoltage and reverse polarity protected.
Impedance	50 Ω	—
Coupling	AC	_

CLK OUT (Sample Clock and Reference Clock Output, Front Panel Connector)

Specification	Value	Comments
Output Impedance	50 Ω	
Logic Type	3.3 V CMOS	_
Maximum Drive Current	±48 mA	_

Trigger

Reference (Stop) Trigger

Specification	n Value		Value	Comments
Trigger Types	Types		Sources	Refer to the following sections and the NI High-Speed Digitizers Help for
and Sources		Window, Hysteresis, Video, Immediate, and Software	CH 0, CH 1, TRIG, PXI_Trig <06>, PFI <01>, PXI Star Trigger, Software, and RTSI <06>	more information about what sources are available for each trigger type.
Time	TDC	Onboard Clock	External Clock	TDC = Time to Digital Conversion Circuit.
Resolution	On 100 ps		N/A]
	Off 10 ns		External Clock Period	
Minimum	TDC		Rearm Time	Holdoff set to 0. Onboard sample clock at maximum rate.
Rearm Time	On		10 µs]
	Off		2 µs	7
Holdoff	TDC	Onboard Clock	External Clock	-
	On	10 µs to 171.79 s	N/A]
	Off	2 µs to 171.79 s	200 × (External Clock Period) to (2 ³² – 1) × (External Clock Period)	
Analog Trigge	er (Edge	, Window, and Hysteresis	Trigger Types)	•
Sources	CH 0 (1	ront panel BNC connector)		-
	CH 1 (1	H 1 (front panel BNC connector)		
	TRIG (front panel BNC connector)		
Trigger Level	CH 0, 0	CH 0, CH 1 TRIG (External Trigger) —		-
Range	100% F	⁼S	±5 V	
Trigger Level Resolution	10 bits	(1 in 1,024)		-
Edge Trigger	CH 0, 0	CH 1	TRIG (External Trigger)	-
Sensitivity	2.5% FS up to 50 MHz, increasing to 5% FS at 100 MHz		0.25 V $_{\rm pk-pk}$ up to 100 MHz, increasing to 1 V $_{\rm pk-pk}$ at 200 MHz	-
Level	CH 0, 0	CH 1	TRIG (External Trigger)	-
Accuracy, Typical	±3.5%	±3.5% FS up to 10 MHz ±0.35 V (±3.5% FS) up to 10 MHz		
Jitter	≤80 ps rms		•	Within ±5 °C of self-calibration temperature.
Trigger Filters	igger Filters Low-Frequency (LF) Reject 50 kHz		High-Frequency (HF) Reject	_
			50 kHz	
Digital Trigge	r (Digita	l Trigger Type)		
Sources	NI PXI-5142 NI PC		NI PCI-5142	_
	PXI_Trig <06> (backplane connector)		RTSI <06>	

Specification	Value		Comments
	PFI<01> (front panel 9-pin mini-circular DIN connector)	PFI<01> (front panel 9-pin mini-circular DIN connector)	
	PXI Star Trigger (backplane connector)		
Video Trigger	(Video Trigger Type)		
Sources	CH 0 (front panel BNC connector)		-
	CH 1 (front panel BNC connector)		
	TRIG (front panel BNC connector)		
Types	Specific Line		-
	Any Line		
	Specific Field		
Standard	Negative sync of NTSC, PAL, or SECAM signal		-

TRIG (External Trigger, Front Panel Connector)

Specification	Value
Connector	BNC
Impedance	1 $M\Omega$ in parallel with 22 pF
Coupling	AC, DC
AC Coupling Cutoff (-3 dB)	12 Hz
Input Voltage Range	±5 V
Maximum Input Overload	Peaks ≤42 V

PFI 0 and PFI 1 (Programmable Function Interface, AUX Front Panel Connectors)

Specification	Value
Connector	9-pin mini-circular DIN
Direction	Bi-directional
As an Input (Trigger)	
Destinations	Start Trigger (Acquisition Arm)
	Reference (Stop) Trigger
	Arm Reference Trigger
	Advance Trigger
Input Impedance	150 κΩ
V _{IH}	2.0 V
V _{IL}	0.8 V
Maximum Input Overload	–0.5 V, 5.5 V
Maximum Frequency	25 MHz
As an Output (Event)	
Sources	Ready for Start
	Start Trigger (Acquisition Arm)
	Ready for Reference
	Reference (Stop) Trigger
	End of Record
	Ready for Advance
	Advance Trigger
	Done (End of Acquisition)
	Probe Compensation (1 kHz, 50% duty cycle square wave, PFI 1 only)
Output Impedance	50 Ω
Logic Type	3.3 V CMOS

Specification	Value
Maximum Drive Current	±24 mA
Maximum Frequency	25 MHz

TClk Specifications

National Instruments TClk synchronization method and the NI-TClk driver are used to align the sample clocks on any number of SMC-based modules in a chassis. For more information about TClk synchronization, refer to the *NI-TClk Synchronization Help*, which is located within the *NI High-Speed Digitizers Help*.

- Specifications are valid for any number of modules installed in one NI PXI-1042 chassis.
- All parameters set to identical values for each SMC-based module.
- Sample Clock set to 100 MS/s and all filters are disabled.
- For other configurations, including multichassis systems, contact NI Technical Support at ni.com/support.

Note Although you can use NI-TCIk to synchronize non-identical modules, these specifications apply only to synchronizing identical modules.

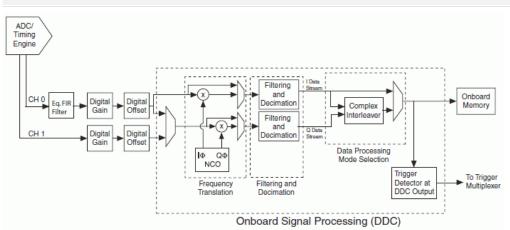
Specification	Value	Comments	
Intermodule SMC Synchr	onizatio	n Using NI-TCIk for Identical Modules (Typical)	
Skew	500 ps	Caused by clock and analog path delay differences. No manual adjustment performed.	
Average Skew After Manual Adjustment	≤5 ps	For information about manual adjustment, refer to the Synchronization Repeatability Optimization topic in the NI-TClk Synchronization Help. For additional help with the adjustment process, contact NI Technical Support at ni.com/support.	
Sample Clock Delay/Adjustment Resolution	≤5 ps	_	

Waveform Specifications

Specification	Va	Comments		
Onboard Memory	64 MB per Channel Option	32 megasamples per channel*	Assumes 2-byte samples. In Complex data processing mode	
Size	256 MB per Channel Option	128 megasamples per channel [*]	(only available when using onboard signal processing), each sample is 4 bytes, so this number is halved.	
Minimum Record Length	1 Sample		_	
Number of Pretrigger Samples	Zero up to full Record Length		Single-record mode and multiple-record mode.	
Number of Posttrigger Samples	Zero up to full Record Length		Single-record mode and multiple-record mode.	
Maximum Number	64 MB/channel	100,000 [†]	[†] It is possible to exceed these numbers if you fetch records	
of Records in Onboard Memory	256 MB/channel	100,000†	while acquiring data. For more information, refer to the <i>NI High-Speed Digitizers Help.</i>	
Allocated	Real Data Processing Mode Complex Data Processing Mode		_	
Onboard Memory per Record	(<i>Record Length</i> × 2 bytes/S) + 200 bytes, rounded up to next multiple of 128 bytes or 512 bytes, whichever is greater	(<i>Record Length</i> × 4 bytes/S) + 200 bytes, rounded up to next multiple of 128 bytes or 512 bytes, whichever is greater		

Onboard Signal Processing (OSP)

NI 5142 Onboard Signal Processing Block Diagram



Note To use onboard signal processing (OSP) on the NI 5142, the DDC Enabled property/attribute must be set to TRUE.

The following four OSP operations are available:

- Send one IF signal to CH 0 and perform quadrature downconversion on the signal (complex data is returned).
- Send I and Q baseband signals to CH 0 and CH 1 and perform alias-protected decimation (complex data is returned).
- Send a signal to CH 0 and perform alias-protected decimation (real data is returned).
- Send a signal to CH 0 and perform real downconversion on the signal (real data is returned).

Specification	Va	llue	Comments	
OSP General	-1			
Number of Digital Downconverters (DDCs)	1		-	
Data Processing Modes	Real (I path only) Complex (IQ)		Complex mode is used for both IQ baseband decimation and quadrature downconversion.	
OSP Decimation Range	1, 2, 4, 6, 8, 10 12 to 4,096 (Multiple 4,096 to 8,192 (Multi 8,192 to 16,384 (Multi	ples of 8)	OSP decimation protects acquired data from high-frequency aliasing within the ADC Nyquist zone, whereas non-OSP decimation does not. Non-OSP decimation and OSP decimation are mutually exclusive.	
Sample Rate Range	Internal Sample Clock Timebase 6.1 kS/s – 100 MS/s (Real or Complex)	External Sample Clock Timebase Sample Clock Timebase/OSP Decimation	For sample rates less than 6.1 kS/s, use an external sample clock or perform additional software decimation.	
Bandwidth	Real Flat Bandwidth Complex Flat Bandw Rate	= 0.4 × Sample Rate idth = 0.8 × Sample	Example: Complex bandwidth is 40 MHz with a Complex Sample Rate of 50 MS/s.	
Digital Gain and Offs	et		·	
Digital Gain and Offset Resolution	18 bits		-	
Digital Gain Range	–1.5 to +1.5 Values <1 attenua	te user data	-	
Digital Offset Range	(–0.4 × Vertical Rang Range)	ge) to (+0.4 × Vertical	Applied after Digital Gain.	
Output	(ADC Data × Digital	Gain) + Digital Offset	(–0.5 × Vertical Range) ≤ Output ≤ (+0.5 × Vertical Range)	
Numerically-Controlle	ed Oscillator (NCO)			
Frequency Range	Internal Sample Clock Timebase 0 – 50 MHz	External Sample Clock Timebase 0 Hz to (0.5 × Sample Clock Timebase)	Undersampling can be used for carrier frequencies >50 MHz.	
Frequency Resolution	355 nHz	Sample Clock Timebase / 2 ⁴⁸	-	
I and Q Phase Resolution	0.0055 °		-	
Tuning Time	1 ms		-	
Digital Performance	~			
Maximum NCO Spur	r <-100 dBFS		-	
Decimating Filter Passband Ripple	<0.1 dB		Passband is from 0 to (0.4 × IQ Rate).	
Decimating Filter Out-of-Band Suppression	>80 dB		Stopband suppression from (0.6 × IQ Rate).	

Specification	Value	Comments		
IF Demodulation Performance (Typical)				
Modulation Configuration Measurement Type Value				

GSM Physical Layer ^{1, 2, 8}	Modulation Error Ratio (MER)	62 dB	_
	Error Vector Magnitude (EVM)	<0.2% rms	
W-CDMA Physical Layer ^{1, 3, 8}	Modulation Error Ratio (MER)	52 dB	—
	Error Vector Magnitude (EVM)	<0.4% rms	
DVB Physical Layer ^{1, 4, 8}	Modulation Error Ratio (MER)	48 dB	—
	Error Vector Magnitude (EVM)	<0.4% rms	
20 MSymbols/s, 64 QAM ^{1, 5, 8}	Modulation Error Ratio (MER)	39 dB	—
	Error Vector Magnitude (EVM)	<0.8% rms	
26.09 MSymbols/s, 64 QAM ^{1, 6, 8}	Modulation Error Ratio (MER)	36 dB	30 MHz bandwidth
	Error Vector Magnitude (EVM)	<1.0% rms	
34.78 MSymbols/s 64 QAM ^{1, 7, 8}	Modulation Error Ratio (MER)	32 dB	40 MHz bandwidth
	Error Vector Magnitude (EVM)	<1.6% rms	

 1 Vertical Range = 1 V $_{pk\text{-}pk}$, Input Impedance = 50 $\Omega,$ no analog filter, 25 MHz carrier

² Sample Rate = 1.25 MS/s, MSK modulation, 270.833 kSymbols/s, Gaussian, BT = 0.3

³ Sample Rate = 6.25 MS/s, QPSK modulation, 3.84 MSymbols/s, root raised cosine, alpha = 0.22

⁴ Sample Rate = 10 MS/s, 32 QAM modulation, 6.92 MSymbols/s, root raised cosine, alpha = 0.15

⁵ Sample Rate = 50 MS/s, 64 QAM modulation, 20 MSymbols/s, root raised cosine, alpha = 0.15
 ⁶ Sample Rate = 50 MS/s, 64 QAM Modulation, 26.09 MSymbols/s, root raised cosine, alpha = 0.15

⁷ Sample Rate = 50 MS/s, 64 QAM Modulation, 34.78 MSymbols/s, root raised cosine, alpha = 0.15

⁸ Demodulation, including resampling (sample rate conversion) and pulse shaping, was done with the NI Modulation Toolkit in the host PC/controller.

Specification	Value		Comments
IQ Baseband Demodulation Performance (Typical)			
Modulation Configuration	Measurement Type	Value	—
GSM Physical Layer ^{1, 2, 6, 7}	Modulation Error Ratio (MER)	41 dB	—
	Error Vector Magnitude (EVM)	<0.8% rms	
W-CDMA Physical Layer ^{1, 3, 6, 7}	Modulation Error Ratio (MER)	41 dB	—
	Error Vector Magnitude (EVM)	<0.9% rms	
DVB Physical Layer 1, 4, 6, 7	Modulation Error Ratio (MER)	40 dB	—
	Error Vector Magnitude (EVM)	<0.9% rms	
20 MSymbols/s 64 QAM ^{1, 5, 6, 7}	Modulation Error Ratio (MER)	33 dB	—
	Error Vector Magnitude (EVM)	<1.4% rms	

 1 Vertical Range = 1 $V_{pk\text{-}pk}$, Input Impedance = 50 $\Omega,$ no analog filter

² Sample Rate = 1.25 MS/s, MSK modulation, 270.833 kSymbols/s, Gaussian, BT = 0.3

³ Sample Rate = 6.25 MS/s, QPSK modulation, 3.84 MSymbols/s, root raised cosine, alpha = 0.22

⁴ Sample Rate = 10 MS/s, 32 QAM modulation, 6.92 MSymbols/s, root raised cosine, alpha = 0.15

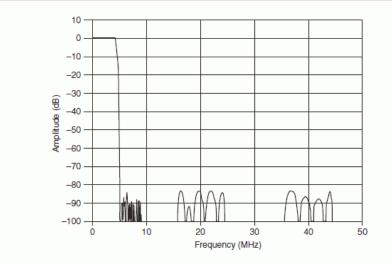
⁵ Sample Rate = 50 MS/s, 64 QAM modulation, 20 MSymbols/s, root raised cosine, alpha = 0.15

⁶ Demodulation, including resampling (sample rate conversion) and pulse shaping, done with the NI Modulation Toolkit in the host PC/controller.

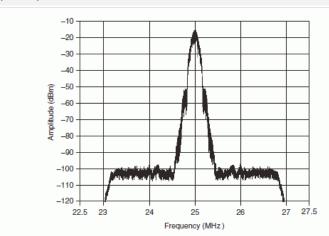
⁷ This is a measurement of system performance. The IQ Baseband generation was implemented with two TClk synchronized NI PXI-5421 arbitrary waveform generators.

Specification	Va	lue	Comments
Waveform Acquisition Times			
Maximum Acquisition Time	64 MB	256 MB	For Complex (IQ) mode, the acquisition time is halved.
Sample Rate = 100 MS/s, OSP Disabled	0.336 s	1.34 s	
Sample Rate = 1 MS/s, Real Mode, OSP Enabled	33.6 s	2 min, 14 s	
Sample Rate = 100 kS/s, Real Mode, OSP Enabled	5 min, 36 s	22 min, 22 s	

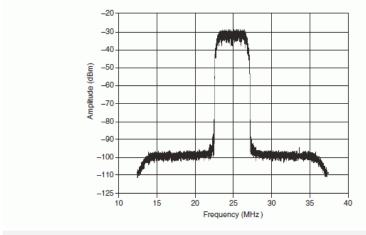
Decimation Filter Frequency Response (Real Mode), Sample Rate = 10 MS/s

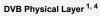


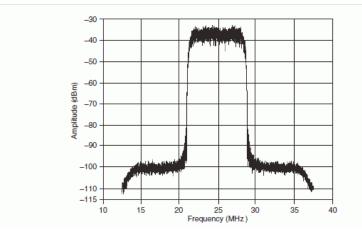
GSM Physical Layer ^{1, 2}



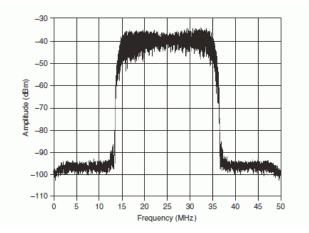
W-CDMA Physical Layer ^{1, 3}







20 MSymbols/s 64 QAM ^{1, 5}



 1 Vertical Range = 1 $V_{pk\text{-}pk\text{-}}$ input impedance = 50 $\Omega,$ no analog filter, 25 MHz carrier

² Sample Rate = 4.17 MS/s, MSK modulation, 270.833 kSymbols/s, Gaussian, BT = 0.3

³ Sample Rate = 25 MS/s, QPSK modulation, 3.84 MSymbols/s, root raised cosine, alpha = 0.22

⁴ Sample Rate = 25 MS/s, 32 QAM modulation, 6.92 MSymbols/s, root raised cosine, alpha = 0.15

⁵ Sample Rate = 50 MS/s, 64 QAM modulation, 20 MSymbols/s, root raised cosine, alpha = 0.15

Calibration

Specification	Value
Self-Calibration	Self-calibration is done on software command. The calibration corrects for gain, offset, frequency response, triggering, and timing adjustment errors for all input ranges.
External Calibration (Factory Calibration)	The external calibration calibrates the VCXO and the voltage reference. Appropriate constants are stored in nonvolatile memory.
Interval for External Calibration	2 years
Warm-Up Time	15 minutes

Power

Specification	Typical Value		
	NI PXI-5142	NI PCI-5142	
+3.3 VDC	1.0 A	3.4 A	
+5 VDC	1.7 A	2.7 A	
+12 VDC	800 mA	110 mA	
-12 VDC	270 mA	0 A	
Total Power	24.7 W	26.1 W	

Software

Specification	Value
Driver Software	NI-SCOPE 3.0 or later.

Specification	Value
	NI-SCOPE is an IVI-compliant driver that allows you to configure, control, and calibrate the NI 5142. NI-SCOPE provides application programming interfaces for many development environments.
Application Software	NI-SCOPE provides programming interfaces, documentation, and examples for the following application development environments: LabVIEW LabWindows [™] /CVI [™] Measurement Studio Microsoft Visual C/C++ Microsoft Visual Basic
Interactive Soft Front Panel and Configuration	The Scope Soft Front Panel 2.4 or later supports interactive control of the NI 5142. The Scope Soft Front Panel is included on the NI-SCOPE CD. National Instruments Measurement & Automation Explorer (MAX) also provides interactive configuration and test tools for the NI 5142. MAX is included on the NI-SCOPE CD.

Environment

NI PXI-5142

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Note To ensure that the NI PXI-5142 cools effectively, follow the guidelines in the Maintain Forced-Air Cooling Note to Users included in the NI PXI-5142 kit. The NI PXI-5142 is intended for indoor use only.

Specification	Value	Comments
Operating Temperature	0 °C to +55 °C in all NI PXI chassis except the following:	-
	0 °C to +45 °C when installed in an NI PXI-1000/B or PXI-101 <i>x</i> chassis.	
	Meets IEC-60068-2-1 and IEC-60068-2-2.	
Storage Temperature	-40 °C to +71 °C. Meets IEC-60068-2-1 and IEC-60068-2-2.	_
Operating Relative Humidity	10% to 90%, noncondensing. Meets IEC-60068-2-56.	_
Storage Relative Humidity	5% to 95%, noncondensing. Meets IEC-60068-2-56.	—
Operating Shock	30 g, half-sine, 11 ms pulse. Meets IEC-60068-2-27. Test profile developed in accordance with MIL-PRF-28800F.	—
Storage Shock	50 g, half-sine, 11 ms pulse. Meets IEC-60068-2-27. Test profile developed in accordance with MIL-PRF-28800F.	—
Operating Vibration	5 Hz to 500 Hz, 0.31 g _{rms} . Meets IEC-60068-2-64.	-
Storage Vibration	5 Hz to 500 Hz, 2.46 g _{rms} : Meets IEC-60068-2-64. Test profile exceeds requirements of MIL-PRF-28800F, Class 3.	-
Altitude	2,000 m maximum (at 25 °C ambient temperature)	—
Pollution Degree	2	_

NI PCI-5142

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Note To ensure that the NI PCI-5142 cools effectively, make sure that the chassis in which it is used has active cooling that provides at least some airflow across the PCI card cage. To maximize airflow and extend the life of the device, leave any adjacent PCI slots empty. Refer to the *Maintain Forced-Air Cooling Note to Users* included in the NI PCI-5142 kit for important cooling information. The NI PCI-5142 is intended for indoor use only.

Specification	Value	Comments
Operating Temperature	0 °C to +45 °C. Meets IEC-60068-2-1 and IEC-60068-2-2.	-
Storage Temperature	-40 °C to +71 °C. Meets IEC-60068-2-1 and IEC-60068-2-2.	-
Operating Relative Humidity	10% to 90%, noncondensing. Meets IEC-60068-2-56.	_
Storage Relative Humidity	5% to 95%, noncondensing. Meets IEC-60068-2-56.	_
Storage Shock	50 g, half-sine, 11 ms pulse. Meets IEC-60068-2-27. Test profile developed in accordance with MIL-PRF-28800F.	_
Storage Vibration	5 Hz to 500 Hz, 2.46 g _{rms} . Meets IEC-60068-2-64. Test profile exceeds requirements of MIL-PRF-28800F, Class 3.	-
Altitude	2,000 m maximum (at 25 °C ambient temperature)	_
Pollution Degree	2	_

Safety, Electromagnetic Compatibility, and CE Compliance

Safety Standards

This product is designed to meet the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1

Note For UL and other safety certifications, refer to the product label or the Online Product Certification section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- · EN 61326 (IEC 61326): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

Note For the standards applied to assess the EMC of this product, refer to the Online Product Certification section.

Note For EMC compliance, operate this device with RG223/U or equivalent shielded cable. Operate according to product documentation.

CE Compliance (6

This product meets the essential requirements of applicable European Directives, as amended for CE marking, as follows:

2006/95/EC; Low-Voltage Directive (safety)

2004/108/EC; Electromagnetic Compatibility Directive (EMC)

Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit ni.com/certification, search by module number or product line, and click the appropriate link in the Certification column.

Environmental Management

National Instruments is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial not only to the environment but also to NI customers.

For additional environmental information, refer to the NI and the Environment Web page at ni.com/environment. This page contains the environmental regulations and directives with which NI complex, as well as other environmental information not included in this document.

Waste Electrical and Electronic Equipment (WEEE)



EU Customers At the end of the product life cycle, all products *must* be sent to a WEEE recycling center. For more information about WEEE recycling centers, National Instruments WEEE initiatives, and compliance with WEEE Directive 2002/96/EC on Waste Electrical and Electronic Equipment, visit ni.com/environment/weee.htm.

电子信息产品污染控制管理办法 (中国 RoHS)

中国客户 National Instruments 符合中国电子信息产品中限制使用某些有害物质指令 (RoHS)。 关于 National Instruments 中国 RoHS 合規性信息, 诸登录 ni.com/environment/rohs_china。 (For information about China RoHS compliance, go to ni.com/environment/rohs_china.)

Physical

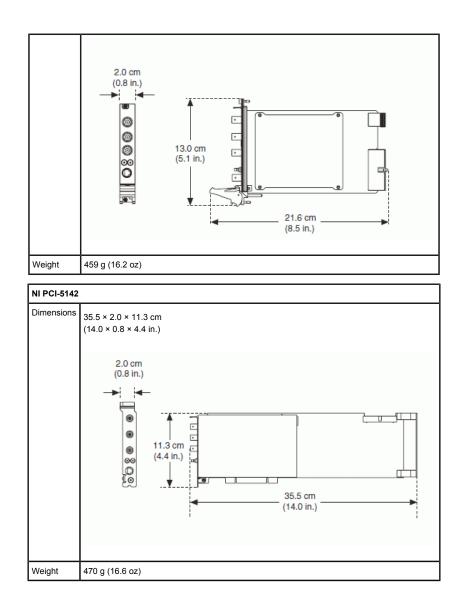
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Front Panel Connectors

Label	Function	Connector Type		
CH 0	Analog Input	BNC female		
CH 1	Analog Input	BNC female		
TRIG	External Trigger	BNC female		
CLK IN	Sample Clock Input and Reference Clock Input	SMB jack		
CLK OUT	Sample Clock Output and Reference Clock Output	SMB jack		
AUX I/O	PFI 0, PFI 1	9-pin mini-circular DIN		
NI PXI-51	NI PXI-5142 Front Panel Indicators			
Label	Function	For more information about front panel labels, refer to the NI High-Speed		
ACCESS	The ACCESS LED indicates the status of the PCI bus and the interface from the NI PXI-5142 to the controller.	Digitizers Help.		
ACTIVE	The ACTIVE LED indicates the status of the onboard acquisition hardware of the NI PXI-5142.			

Dimensions and Weight

NI PXI-5142	
	3U, One slot, PXI/cPCI Module 21.6 × 2.0 × 13.0 cm (8.5 × 0.8 × 5.1 in.)



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